onsemi

MOSFET – N-Channel, POWERTRENCH[®]

80 V

FDC3512

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low R_{DS(ON)} and fast switching speed.

Features

- 3.0 A. 80 V
 - $R_{DS(ON)} = 77 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$
 - $R_{DS(ON)} = 88 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- High Performance Trench Technology for Extremely Low R_{DS(ON)}
- Low Gate Charge (13 nC Typical)
- High Power and Current Handling Capability
- Fast Switching Speed
- This Device is Pb-Free, Halide Free and is RoHS Compliant

Applications

• DC/DC Converter

Symbol	P	arameter	Ratings	Unit		
V _{DSS}	Drain-Source	Voltage	80	V		
V _{GSS}	Gate-Source Voltage		±20	V		
I _D	Drain Current	Continuous (Note 1a)	3.0	Α		
		Pulsed	20			
PD	Maximum Power	(Note 1a)	1.6	W		
	Dissipation	(Note 1b)	0.8			
T _J , T _{STG}	Operating and Storage Junction Temperature Range		–55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit	
Reja	Thermal Resistance, Junction–to–Ambient (Note 1a)	78	°C/W	
Rejc	Thermal Resistance, Junction–to–Case (Note 1)	30	°C/W	

1. $R_{\theta,IA}$ is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

a. 78°C/W when mounted on a 1 in² pad of 2 oz copper on FR-4 board. b. 156°C/W when mounted on a minimum pad.

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	77 mΩ @ 10 V	3.0 A
	88 mΩ @ 6 V	



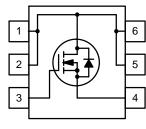


П 352 M \circ 352 = Device Code

MARKING DIAGRAM

PIN CONNECTION

M = Date Code



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

FDC3512

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
DRAIN-SO	URCE DIODE AVALANCHE RATINGS (Note 2)				
W _{DSS}	Drain–Source Avalanche Energy	Single Pulse, V_{DD} = 40 V, I_D = 3.0 A	-	-	90	mJ
I _{AR}	Drain–Source Avalanche Current		-	-	3.0	А
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	80	_	_	V
$\frac{\Delta {\rm BV}_{\rm DSS}}{\Delta {\rm T}_{\rm J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	80	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	-100	nA
N CHARA	ACTERISTICS (Note 2)	•	•	•	•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	2.4	4	V
$\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	_	-6	-	mV/°C
R _{DS(on)}	Static Drain–Source On Resistance	$\begin{split} V_{GS} &= 10 \text{ V}, \text{ I}_{D} = 3.0 \text{ A} \\ V_{GS} &= 6.0 \text{ V}, \text{ I}_{D} = 2.8 \text{ A} \\ V_{GS} &= 10 \text{ V}, \text{ I}_{D} = 3.0 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C} \end{split}$		56 61 97	77 88 141	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	10	-	-	А
9FS	Forward Transconductance	V _{DS} = 10 V, I _D = 3.0 A	-	14	-	S
YNAMIC	CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 40 V, V_{GS} = 0 V, f = 1.0 MHz	-	634	_	pF
C _{oss}	Output Capacitance		_	58	-	pF
C _{rss}	Reverse Transfer Capacitance		_	28	-	pF
WITCHIN	G CHARACTERISTICS (Note 2)	•	•			
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 1 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	7	14	ns
t _r	Turn–On Rise Time	$R_{GEN} = 6 \Omega$	-	3	6	ns
t _{d(off)}	Turn–Off Delay Time		-	24	28	ns
t _f	Turn–Off Fall Time		-	4	8	ns
Qg	Total Gate Charge	V_{DS} = 40 V, I _D = 3.0 A, V _{GS} = 10 V	-	13	18	nC
Q _{gs}	Gate-Source Charge		-	2.4	-	nC
Q _{gd}	Gate-Drain Charge		-	2.8	-	nC
RAIN-SO	URCE DIODE CHARACTERISTICS ANI	D MAXIMUM RATING				
IS	Maximum Continuous Drain-Source Diode Forward Current		-	-	1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.3 A (Note 2)	_	0.8	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 3.0 \text{ A}, d_{iF}/d_t = 300 \text{ A}/\mu \text{s} \text{ (Note 2)}$	_	28.2	-	nS
Q _{rr}	Diode Reverse Recovery Charge	1	_	48	1	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.

FDC3512

TYPICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

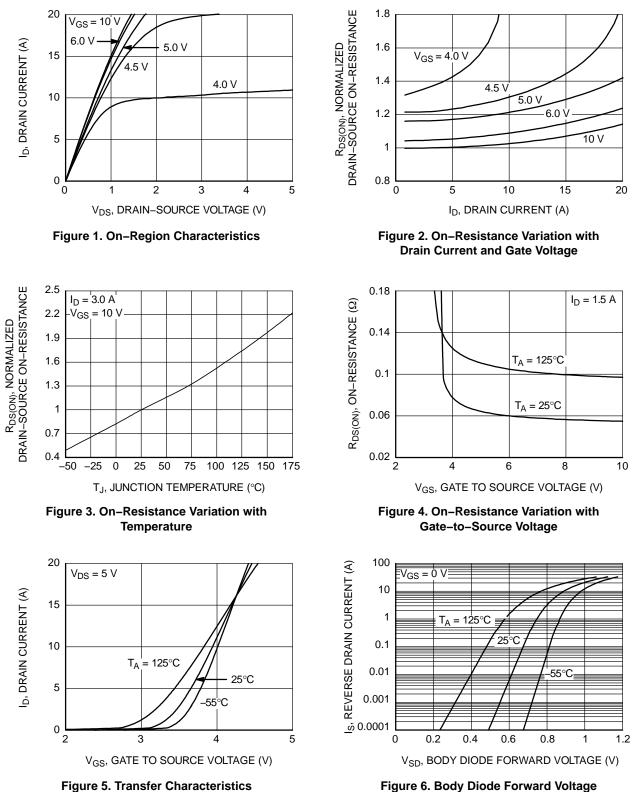


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

FDC3512

TYPICAL CHARACTERISTICS (continued)

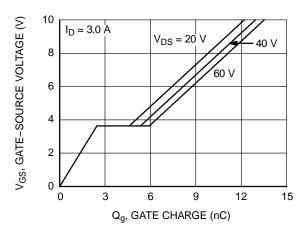


Figure 7. Gate Charge Characteristics

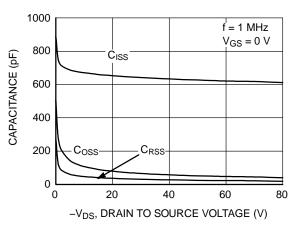


Figure 8. Capacitance Characteristics

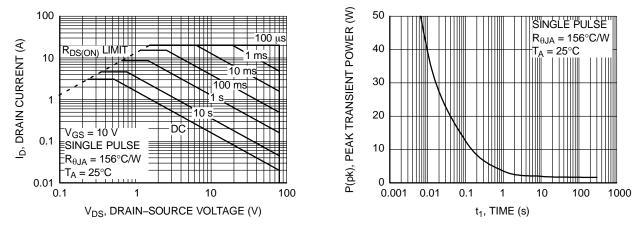
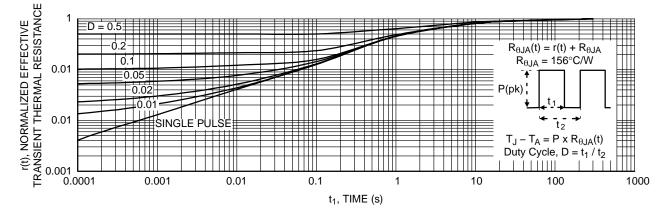
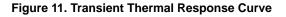


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation





Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

PACKAGE MARKING AND ORDERING INFORMATION

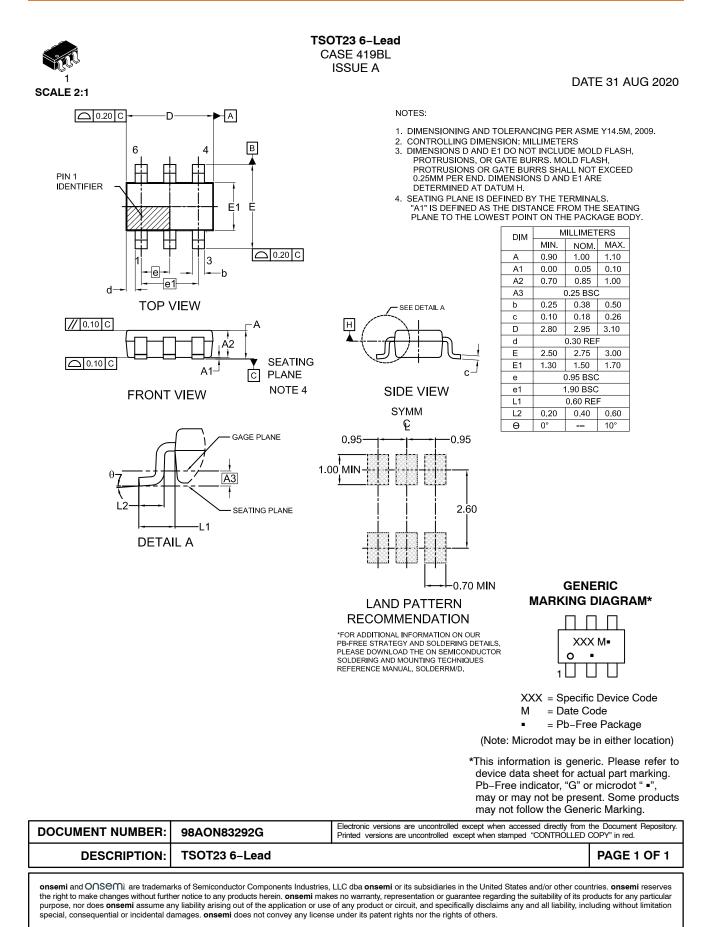
Device	Device Marking	Package Type	Reel Size	Tape Width	Shipping [†]
FDC3512	352	TSOT23 6–Lead (Pb–Free)	7"	8 mm	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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